DATA SHEET



SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

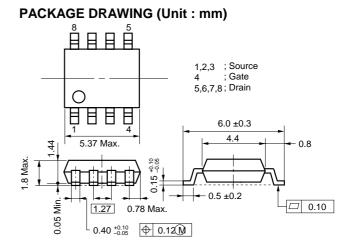
This product is N-Channel MOS Field Effect Transistor designed for DC/DC converters and power management switch.

FEATURES

- Low on-resistance $R_{DS(on)1} = 9.3 \text{ m}\Omega \text{ (TYP.)} (V_{GS} = 10 \text{ V}, \text{ ID} = 4.5 \text{ A})$ $R_{DS(on)2} = 13.8 \text{ m}\Omega \text{ (TYP.)} (V_{GS} = 4.5 \text{ V}, \text{ ID} = 4.5 \text{ A})$
- Low Ciss : Ciss = 1850 pF (TYP.)
- Built-in G-S protection diode
- Small and surface mount package (Power SOP8)

ORDERING INFORMATION

PART NUMBER	PACKAGE
μ PA1709G	Power SOP8



EQUIVARENT CIRCUIT

ABSOLUTE MAXIMUM RATINGS (TA = 25°C, All terminals are connected.)

•				
Drain to Source Voltage (Vgs = 0 V)	Vdss	40	V	
Gate to Source Voltage (VDS = 0 V)	Vgss	±25	V	Drain
Drain Current (DC)	D(DC)	±9.0	А	
Drain Current (pulse) ^{Note1}	D(pulse)	±36	А	Gate
Total Power Dissipation $(T_A = 25^{\circ}C)^{Note2}$	Pτ	2.0	W	
Channel Temperature	Tch	150	°C	Gate
Storage Temperature	Tstg	–55 to + 150	°C	Protection Source Diode

Notes 1. PW \leq 10 μ s, Duty Cycle \leq 1 %

2. Mounted on ceramic substrate of 1200 mm² x 0.7 mm

Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

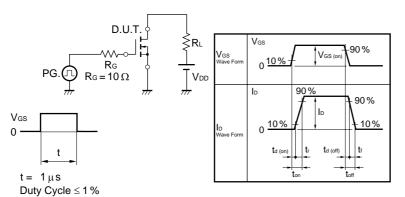
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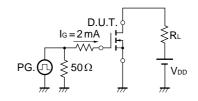
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain to Source On-state Resistance	RDS(on)1	Vgs = 10 V, Id = 4.5 A		9.3	12.5	mΩ
	RDS(on)2	Vgs = 4.5 V, Id = 4.5 A		13.8	20.0	mΩ
Gate to Source Cut-off Voltage	VGS(off)	Vds = 10 V, Id = 1 mA	1.5	2.0	2.5	V
Forward Transfer Admittance	y _{fs}	Vds = 10 V, Id = 4.5 A	8.0	14		S
Drain Leakage Current	Ibss	Vds = 40 V, Vgs = 0 V			10	μA
Gate to Source Leakage Current	lgss	$V_{GS} = \pm 25 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			±10	μA
Input Capacitance	Ciss	V _{DS} = 10 V		1850		pF
Output Capacitance	Coss	V _{GS} = 0 V		790		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		330		pF
Turn-on Delay Time	td(on)	ID = 4.5 A		27		ns
Rise Time	tr	$V_{GS(on)} = 10 V$		95		ns
Turn-off Delay Time	td(off)	V _{DD} = 20 V		110		ns
Fall Time	tr	$R_G = 10 \Omega$		70		ns
Total Gate Charge	QG	ID = 9.0 A		43.0		nC
Gate to Source Charge	QGS	Vdd = 32 V		6.0		nC
Gate to Drain Charge	Qgd	Vgs = 10 V		14.0		nC
Body Diode Forward Voltage	VF(S-D)	IF = 9.0 A, VGS = 0 V		0.78		V
Reverse Recovery Time	trr	IF = 9.0 A, VGS = 0 V		47		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/ μ s		44		nC

ELECTRICAL CHARACTERISTICS (TA = 25 °C, All terminals are connected.)

TEST CIRCUIT 1 SWITCHING TIME

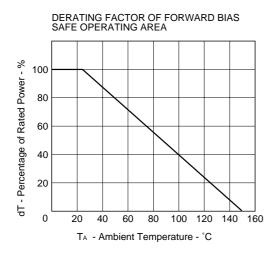


TEST CIRCUIT 2 GATE CHARGE

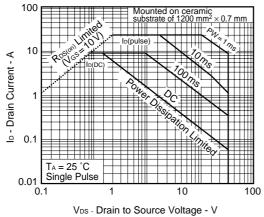


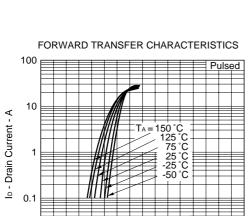
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TYPICAL CHARACTERISTICS (TA = 25 °C)



FORWARD BIAS SAFE OPERATING AREA



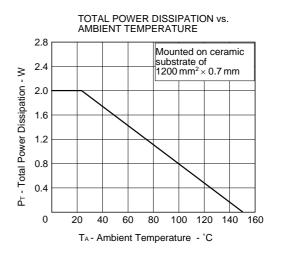


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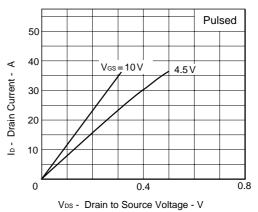
VGS - Gate to Source Voltage - V

0

2

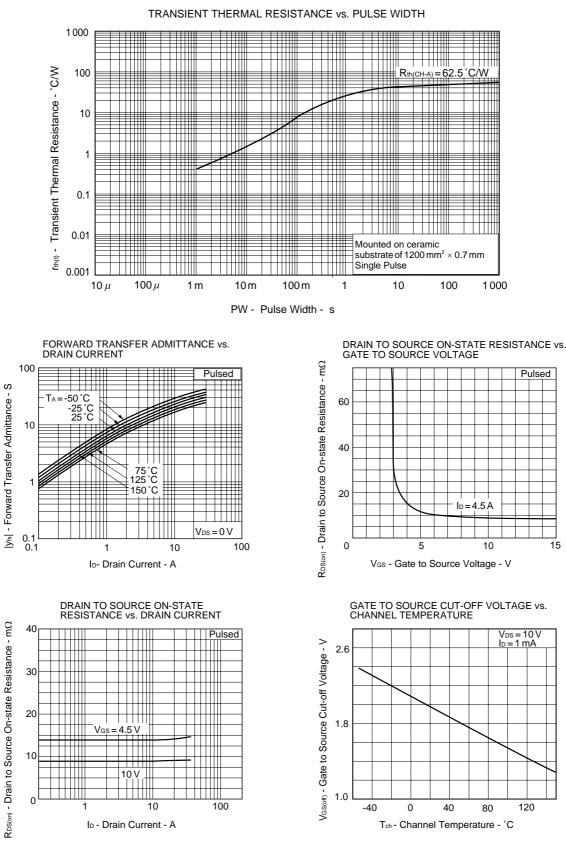


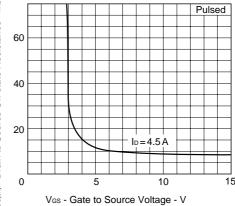


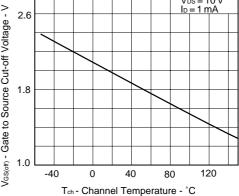


V_{DS}=10V

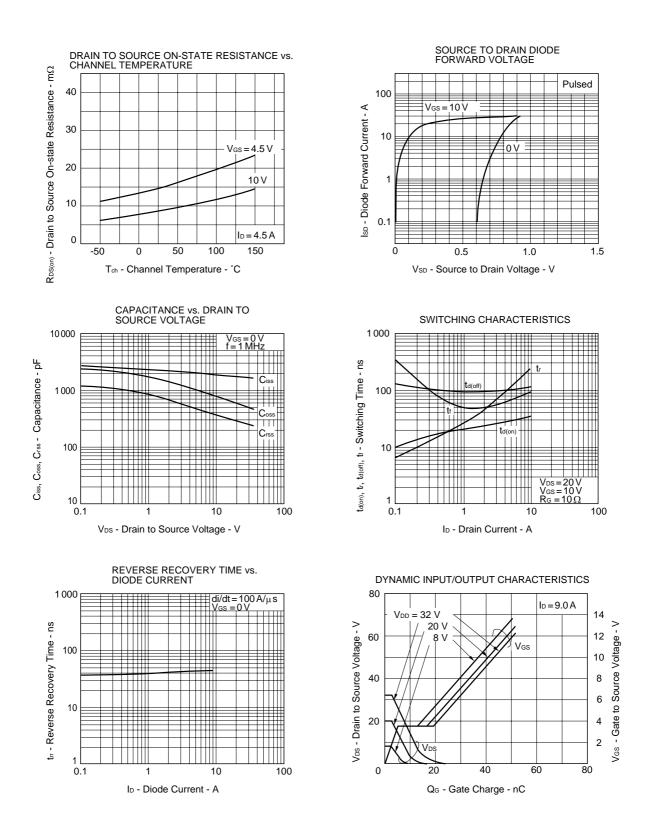
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